退せらいしょうりょう

DECLARATION OF JOINT INVENTORS FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the inventor entitled: "Interfacial Structure for Semiconductor Substrate Processing Chambers and Substrate Transfer Chambers and for Semiconductor Substrate Processing Chambers and Accessory Attachments, and Semiconductor Substrate Processor", the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

l acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

PRIOR FOREIGN APPLICATIONS:

I hereby state that no applications for foreign patents or inventor's certificates have been filed prior to the date of execution of this declaration.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such

willful false statement may jeopardize the validity of the application or any patent issued therefrom.

Full name of inventor:	Craig M. Carpenter
Inventor's Signature:	can by Cupul
Date:	02/18/2002
Residence:	Boise, Idaho
Citizenship:	United States of America
Post Office Address:	4186 East Carnation Court, Boise, ID 82716
	* * * * * * * * * *
Full name of inventor:	Ross S. Dando
Inventor's Signature:	
Date:	02/18/2002
Residence:	Nampa, Idaho
Citizenship:	United States of America

Post Office Address: 3113 Teepee Court, Nampa, ID 83686-7932

	•
Full name of inventor:	Allen P. Mardian
Inventor's Signature:	Me 8. Marlin 2/18/02
Date:	
Residence:	Boise, Idaho
Citizenship:	United States of America
Post Office Address:	5299 Marcliffe Avenue, Boise, ID 82704
	* * * * * * * * * *
Full name of inventor:	Kevin T. Hamer
Inventor's Signature:	AS. Marrie
Date:	2/18/02
Residence:	Meridian, Idaho
Citizenship:	United States of America
Post Office Address:	2433 North Victor Way, Meridian, ID 83642
	* * * * * * * * * *
Full name of inventor:	Raynald B. Cantin
Inventor's Signature:	Karnel & Conto
Date:	2/18/02
Residence:	Boise, Idaho
Citizenship:	United States of America
Post Office Address:	1165 South Dale Street No. 303 Boice ID 92706

Full name of inventor:	Philip H. Campbelt
Inventor's Signature:	Chiff Cyll
Date:	2-19-02
Residence:	Meridian, Idaho
Citizenship:	United States of America
Post Office Address:	2724 Mule Deer Way, Meridian, ID 83642
	* * * * * * * * * *
Full name of inventor:	Kimberly R. Tschepen
Inventor's Signature:	
Date:	
Residence:	Boise, Idaho
Citizenship:	United States of America
Post Office Address:	4420 North Foothill Drive, Boise, ID 83703
	* * * * * * * * * * *
Full name of inventor:	Randy W. Mercil
Inventor's Signature:	Karola I hand
Date:	2/20/02
Residence:	Boise, Idaho
Citizenship:	United States of America
Post Office Address:	5639 South Amaryllis Place, Boise, ID 83716